

a first substrate and a second substrate being bonded to each other, said first and second substrates being opposite to each other with a gap provided therebetween;

a pixel matrix circuit and a driver circuit for driving the pixel matrix circuit, each of the pixel matrix circuit and the driver circuit being formed over the first substrate;

an adhesive layer being formed closely to the sides of the first and second substrates; and

a frame member being formed closely to the adhesive layer.

Please add new claims 9-32 as follows:

--9. A display device comprising:

a first substrate;

a pixel matrix circuit formed over the first substrate;

a second substrate opposed to said first substrate with a gap therebetween;

an adhesive disposed on at least one side edge of the first substrate and one side edge of the second substrate to fill an opening therebetween; and

a tape covering said adhesive wherein said tape extends beyond edges of the adhesive to cover portions of the first and second substrates.

10. The display device according to claim 9 wherein said display device is a liquid crystal device.

11. The display device according to claim 9 wherein said display device is an EL display device.

12. The display device according to claim 9 further comprising a driver circuit formed over the first substrate for driving said pixel matrix circuit.

13. The display device according to claim 9 wherein said tape comprises a metallic material.

14. The display device according to claim 9 wherein said adhesive comprises a UV setting resin.

15. The display device according to claim 9 wherein said adhesive comprises a thermosetting resin.

16. An organic EL display device comprising:

a first substrate;

a pixel matrix circuit formed over the first substrate;

a second substrate opposed to said first substrate with a gap therebetween;

an adhesive disposed on at least one side edge of the first substrate and one side edge of the second substrate to fill an opening therebetween; and

a tape covering said adhesive wherein said tape extends beyond edges of the adhesive to cover portions of the first and second substrates.

17. The display device according to claim 16 wherein said adhesive comprises a thermosetting resin.

18. The display device according to claim 16 further comprising a driver circuit formed over the first substrate for driving said pixel matrix circuit.

19. The display device according to claim 16 wherein said tape comprises a metallic material.

20. The display device according to claim 16 wherein said adhesive comprises a UV setting resin.

21. A display device comprising:

a first substrate;

a pixel matrix circuit formed over the first substrate;

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a second substrate opposed to said first substrate with a gap therebetween;
an adhesive disposed on at least one side edge of the first substrate and one side edge of the second substrate to fill an opening therebetween; and
a frame covering said adhesive wherein said frame extends beyond edges of the adhesive to cover portions of the first and second substrates.

22. The display device according to claim 21 wherein said display device is a liquid crystal device.

23. The display device according to claim 21 wherein said display device is an EL display device.

24. The display device according to claim 21 further comprising a driver circuit formed over the first substrate for driving said pixel matrix circuit.

25. The display device according to claim 21 wherein said frame comprises a metallic material.

26. The display device according to claim 21 wherein said adhesive comprises a UV setting resin.

27. The display device according to claim 21 wherein said adhesive comprises a thermosetting resin.

28. An organic EL display device comprising:
a first substrate;
a pixel matrix circuit formed over the first substrate;
a second substrate opposed to said first substrate with a gap therebetween;
an adhesive disposed on at least one side edge of the first substrate and one side edge of the second substrate to fill an opening therebetween; and

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cont'd

a frame covering said adhesive wherein said frame extends beyond edges of the adhesive to cover portions of the first and second substrates.

29. The display device according to claim 28 wherein said adhesive comprises a thermosetting resin.

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end
30. The display device according to claim 28 further comprising a driver circuit formed over the first substrate for driving said pixel matrix circuit.

31. The display device according to claim 28 wherein said frame comprises a metallic material.

32. The display device according to claim 28 wherein said adhesive comprises a UV setting resin.--
